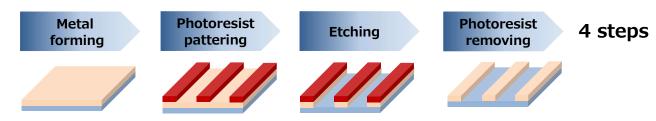
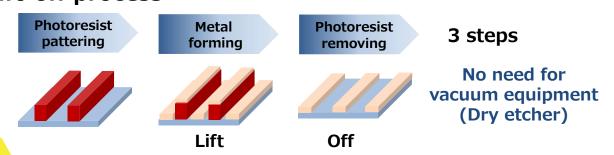
NAGASE Photoresist for Lift-off Process

Lift-off Process

Etching process (Conventional)

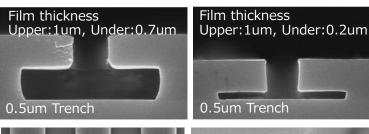


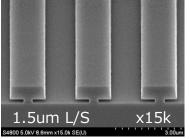
Lift-off process

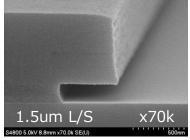


Product by i-line stepper exposure (NA=0.45)

Bi-layer type BLX series (Under layer)

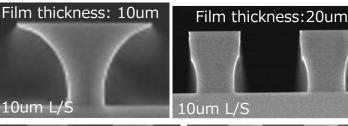


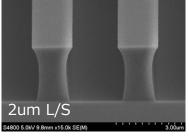


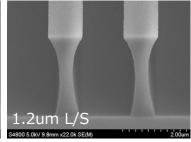


- No intermixing
- Applicable to various upper layer
- Selectable of exposure wavelength depending on upper layer

Single-layer type NPR9700 series







- Positive-tone type
- Simple process
- Good step coverage
- Suitable anti-tapered profile

Customizable for customer needs

